

2024 7th International Conference on Mechanical Engineering and Applied Composite Materials

Singapore | September 23-25, 2024

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CALL FOR PAPERS

2024 7th International Conference on Mechanical Engineering and Applied Composite Materials (MEACM 2024) will be held in **Singapore** during **September 23-25, 2024**. The conference program covered invited, oral, and poster presentations from scientists working in similar areas to establish platforms for collaborative research projects in this field. This conference will bring together leaders from mechanical engineering and applied composite materials to exchange and share their experiences, present research results, explore collaborations and to spark new ideas, with the aim of developing new projects and exploiting new technology in this field.

Topics

T1: Mechanical Engineering

Precision Mechanics, Mechatronics
Engineering Materials
Mechanical Materials
Mechanical Manufacturing and Automation
Mechanics of Materials and Strength of Materials

T2: Mechanical Science and Technology

Dynamics of Machinery
Precision Manufacturing and Processing
Instrument Science and Technology
Mechanical Design and Theory
Gearing and Transmissions

T3: Composite Materials

Metal and Metal Composite
Nonmetal and Metal Composites
Nonmetallic and Nonmetallic Composites
Fiber Composites
Composite Materials Mechanics

Publication

Papers submitted to MEACM 2024 will be reviewed by technical committees of the conference. Accepted full papers will be included in conference proceedings and arranged to be published in proceedings, which will be submitted to major databases like **El Compindex** and **Scopus** etc...

Submission

Papers are suggested to submit by OpenConf submission system or Email.

1. OpenConf submission system:

<https://www.meacm.org/openconf/openconf.php>

2. Email: cfp@meacm.org

Note: Please choose one way to submit and don't repeat the submission.

Important Date

Submission Deadline: July 30, 2024

Acceptance Notification: August 30, 2024

Registration Deadline: September 15, 2024

Conference Date: September 23-25, 2024

Committees

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